SP514

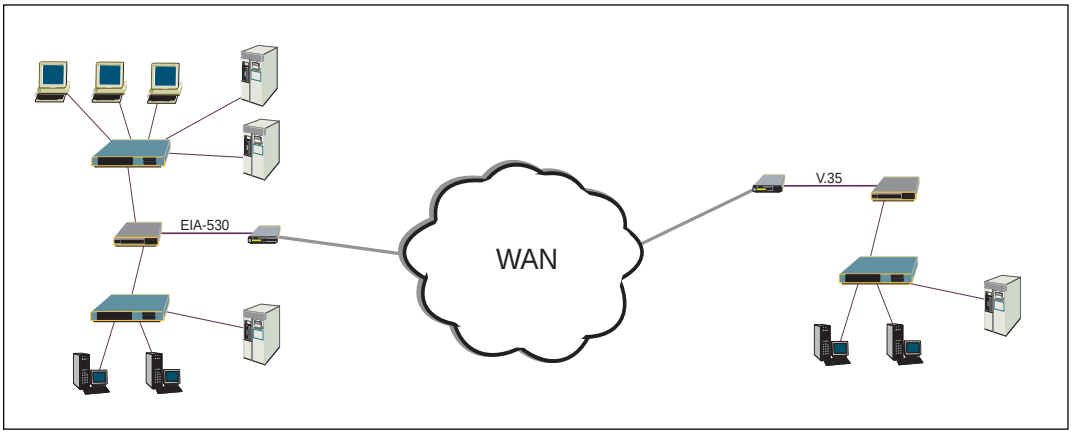
WAN Multi-Mode Serial Transceiver

- +5V Only
- Seven (7) Drivers and Seven (7) Receivers
- Driver and Receiver Tri-State Control
- Reduced V.35 Termination Network
- Pin Compatible with the SP504
- Improved Propagation Delays
- Software Selectable Interface Modes:
  - -RS-232E (V.28)
  - -RS-422A (V.11, X.21)
  - -RS-449 (V.11 & V.10)
  - -RS-485
  - -V.35
  - -EIA-530 (V.11 & V.10)
  - -EIA-530A (V.11 & V.10)
  - -V.36



DESCRIPTION

The **SP514** is a single chip devices that supports eight (8) physical serial interface standards for Wide Area Network connectivity. The product is fabricated using a low power BiCMOS process technology, and incorporates a **Sipex** patented (5,306,954) charge pump allowing +5V only operation. The **SP514** is 100% compatible with the SP504 multi-protocol serial transceiver IC. All applications using the SP504 can also use the **SP514**. The **SP514** has slightly improved AC performance for its V.35 and V.11 drivers and receivers.



 © Copyright 2004 Sipex Corporation

ABSOLUTE MAXIMUM RATINGS

These are stress ratings only and functional operation of the device at these ratings or any other above those indicated in the operation sections of the specifications below is not implied. Exposure to absolute maximum rating conditions for extended periods of time may affect reliability.

V_{CC}.....+7V
Input Voltages:
Logic.....-0.3V to (V_{CC}+0.5V)
Drivers.....-0.3V to (V_{CC}+0.5V)
Receivers.....±15.5V
Output Voltages:
Logic.....-0.3V to (V_{CC}+0.5V)
Drivers.....±15V
Receivers.....-0.3V to (V_{CC}+0.5V)
Storage Temperature.....-65˚C to +150˚C
Power Dissipation.....2000mW
Package Derating:
ø$_{JA}$.....46 °C/W
ø$_{JC}$.....16 °C/W

STORAGE CONSIDERATIONS

Due to the relatively large package size of the 80-pin quad flat-pack, storage in a low humidity environment is preferred. Large high density plastic packages are moisture sensitive and should be stored in Dry Vapor Barrier Bags. Prior to usage, the parts should remain bagged and stored below 40°C and 60%RH. If the parts are removed from the bag, they should be used within 48 hours or stored in an environment at or below 20%RH. If the above conditions cannot be followed, the parts should be baked for four hours at 125°C in order remove moisture prior to soldering. Sipex ships the 80-pin QFP in Dry Vapor Barrier Bags with a humidity indicator card and desiccant pack.The humidity indicator should be below 30%RH.

SPECIFICATIONS

T_A = +25°C and V_{CC} = +4.75V to +5.25V unless otherwise noted.

	MIN.	TYP.	MAX.	UNITS	CONDITIONS
LOGIC INPUTS					
V_{IL}			0.8	Volts	
V_{IH}	2.0			Volts	
LOGIC OUTPUTS					
V_{OL}			0.4	Volts	I_{OUT}= –3.2mA
V_{OH}	2.4			Volts	I_{OUT}= 1.0mA
V.28 DRIVER					
DC Parameters					
Outputs					
Open Circuit Voltage			±15	Volts	per Figure 1
Loaded Voltage	±5.0		±15	Volts	per Figure 2
Short-Circuit Current			±100	mA	per Figure 4
Power-Off Impedance	300			Ω	per Figure 5
AC Parameters					**V_{CC} = +5V & T_A = +25°C for AC parameters**
Outputs					
Transition Time			1.5	µs	per Figure 6; +3V to -3V
Instantaneous Slew Rate			30	V/µs	per Figure 3
Propagation Delay					
t_{PHL}	0.5	1	5	µs	
t_{PLH}	0.5	1	5	µs	
Max.Transmission Rate	120	230		kbps	
V.28 RECEIVER					
DC Parameters					
Inputs					
Input Impedance	3		7	kΩ	per Figure 7
Open-Circuit Bias			+2.0	Volts	per Figure 8
HIGH Threshold		1.7	3.0	Volts	
LOW Threshold	0.8	1.2		Volts	
AC Parameters					**V_{CC} = +5V & T_A = +25°C for AC parameters**
Propagation Delay					
t_{PHL}	50	100	500	ns	
t_{PLH}	50	100	500	ns	

© Copyright 2004 Sipex Corporation

SPECIFICATIONS

T_A = +25°C and V_{CC} = +4.75V to +5.25V unless otherwise noted.

	MIN.	TYP.	MAX.	UNITS	CONDITIONS
V.28 RECEIVER (continued)					
AC Parameters (cont.)					
Max.Transmission Rate	120	230		kbps	
V.10 DRIVER					
DC Parameters					
Outputs					
Open Circuit Voltage	±4.0		±6.0	Volts	per Figure 9
Test-Terminated Voltage	$0.9V_{OC}$			Volts	per Figure 10
Short-Circuit Current			±150	mA	per Figure 11
Power-Off Current			±100	µA	per Figure 12
AC Parameters					**V_{CC} = +5V & T_A = +25°C for AC parameters**
Outputs					
Transition Time			100	ns	per Figure 13; 10% to 90%
Propagation Delay					
t_{PHL}	50	200	1000	ns	
t_{PLH}	50	200	1000	ns	
Max.Transmission Rate	120			kbps	
V.10 RECEIVER					
DC Parameters					
Inputs					
Input Current	–3.25		+3.25	mA	per Figures 14 and 15
Input Impedance	4			kΩ	
Sensitivity			±0.3	Volts	
AC Parameters					**V_{CC} = +5V & T_A = +25°C for AC parameters**
Propagation Delay					
t_{PHL}	50	120	250	ns	
t_{PLH}	50	120	250	ns	
Max.Transmission Rate	120			kbps	
V.11 DRIVER					
DC Parameters					
Outputs					
Open Circuit Voltage			±6.0	Volts	per Figure 16
Test Terminated Voltage	±2.0			Volts	per Figure 17
	$0.5V_{OC}$		$0.67V_{OC}$	Volts	
Balance			±0.4	Volts	per Figure 17
Offset			+3.0	Volts	per Figure 17
Short-Circuit Current			±150	mA	per Figure 18
Power-Off Current			±100	µA	per Figure 19
AC Parameters					**V_{CC} = +5V & T_A = +25°C for AC parameters**
Outputs					
Transition Time		20	40	ns	per Figures 21 and 36; 10% to 90%
Propagation Delay					Using R_L = 100Ω and C_L = 50pF;
t_{PHL}	50	75	95	ns	per Figures 32 and 36
t_{PLH}	50	75	95	ns	per Figures 32 and 36
Differential Skew		20	40	ns	per Figures 32 and 36
Max.Transmission Rate	10			Mbps	
V.11 RECEIVER					
DC Parameters					
Inputs					
Common Mode Range	–7		+7	Volts	
Sensitivity			±0.3	Volts	

 © Copyright 2004 Sipex Corporation

SPECIFICATIONS

T_A = +25°C and V_{CC} = +4.75V to +5.25V unless otherwise noted.

	MIN.	TYP.	MAX.	UNITS	CONDITIONS
V.11 RECEIVER (continued)					
DC Parameters (cont.)					
Input Current	–3.25		±3.25	mA	per Figure 20 and 22
Current w/ 100Ω Termination			±60.75	mA	per Figure 23 and 24
Input Impedance	4			kΩ	
AC Parameters					**V_{CC} = +5V & T_A = +25°C for AC parameters**
Propagation Delay					Using R_L = 100Ω and C_L = 50pF;
t_{PHL}	60	100	125	ns	per Figures 32 and 38
t_{PLH}	60	100	125	ns	per Figures 32 and 38
Differential Skew		20		ns	per Figure 32
Max. Transmission Rate	10			Mbps	
V.35 DRIVER					
DC Parameters					
Outputs					
Test Terminated Voltage	±0.44		±0.66	Volts	per Figure 25
Offset			±0.6	Volts	per Figure 26
Source Impedance	50		150	Ω	per Figure 27
Short-Circuit Impedance	135		165	Ω	per Figure 28
AC Parameters					**V_{CC} = +5V & T_A = +25°C for AC parameters**
Outputs					
Transition Time		30	60	ns	per Figure 29; 10% to 90%
Propagation Delay					
t_{PHL}	50	75	95	ns	per Figures 33 and 36
t_{PLH}	50	75	95	ns	per Figures 33 and 36
Differential Skew		20	40	ns	per Figures 33 and 36
Max.Transmission Rate	10			Mbps	
V.35 RECEIVER					
DC Parameters					
Inputs					
Sensitivity		80		mV	
Source Impedance	90		110	Ω	per Figure 30
Short-Circuit Impedance	135		165	Ω	per Figure 31
AC Parameters					**V_{CC} = +5V & T_A = +25°C for AC parameters**
Propagation Delay					
t_{PHL}	60	115	125	ns	per Figures 33 and 38
t_{PLH}	60	115	125	ns	per Figures 33 and 38
Differential Skew		20		ns	per Figure 33
Max. Transmission Rate	10			Mbps	
POWER REQUIREMENTS					
V_{CC}	4.75	5.00	5.25	Volts	
I_{CC} (No Mode Selected)		30		mA	All I_{CC} values are with V_{CC} = +5V
(V.28/RS-232)		130		mA	f_{IN} = 120kbps; Drivers active & loaded.
(V.11/RS-422)		280		mA	f_{IN} = 2.1Mbps; Drivers active & loaded.
(EIA-530 & RS-449)		250		mA	f_{IN} = 2.1Mbps; Drivers active & loaded.
(V.35)		180		mA	V.35 @ f_{IN} = 2.1Mbps, V.28 @ 20kbps; Drivers active & loaded.
ENVIRONMENTAL AND MECHANICAL					
Operating Temperature Range	0		+70	°C	
Storage Temperature Range	–65		+150	°C	

 © Copyright 2004 Sipex Corporation

OTHER AC CHARACTERISTICS

T_A = +25°C and V_{CC} = +5.0V unless otherwise noted.

PARAMETER	MIN.	TYP.	MAX.	UNITS	CONDITIONS
DRIVER DELAY TIME BETWEEN ACTIVE MODE AND TRI-STATE MODE					
RS-232/V.28 MODE					
t_{PZL}; Tri-state to Output LOW		0.70	5.0	µs	C_L = 100pF, Fig. 34 ; S_1 closed
t_{PZH}; Tri-state to Output HIGH		0.40	2.0	µs	C_L = 100pF, Fig. 34 ; S_2 closed
t_{PLZ}; Output LOW to Tri-state		0.20	2.0	µs	C_L = 100pF, Fig. 34 ; S_1 closed
t_{PHZ}; Output HIGH to Tri-state		0.40	2.0	µs	C_L = 100pF, Fig. 34 ; S_2 closed
RS-423/V.10 MODE					
t_{PZL}; Tri-state to Output LOW		0.15	2.0	µs	C_L = 100pF, Fig. 34 ; S_1 closed
t_{PZH}; Tri-state to Output HIGH		0.20	2.0	µs	C_L = 100pF, Fig. 34 ; S_2 closed
t_{PLZ}; Output LOW to Tri-state		0.20	2.0	µs	C_L = 100pF, Fig. 34 ; S_1 closed
t_{PHZ}; Output HIGH to Tri-state		0.15	2.0	µs	C_L = 100pF, Fig. 34 ; S_2 closed
RS-422/V.11 MODE					
t_{PZL}; Tri-state to Output LOW		2.80	10.0	µs	C_L = 100pF, Fig. 34 & 37; S_1 closed
t_{PZH}; Tri-state to Output HIGH		0.10	2.0	µs	C_L = 100pF, Fig. 34 & 37; S_2 closed
t_{PLZ}; Output LOW to Tri-state		0.10	2.0	µs	C_L = 15pF, Fig. 34 & 37; S_1 closed
t_{PHZ}; Output HIGH to Tri-state		0.10	2.0	µs	C_L = 15pF, Fig. 34 & 37; S_2 closed
V.35 MODE					
t_{PZL}; Tri-state to Output LOW		2.60	10.0	µs	C_L = 100pF, Fig. 34 & 37; S_1 closed
t_{PZH}; Tri-state to Output HIGH		0.10	2.0	µs	C_L = 100pF, Fig. 34 & 37; S_2 closed
t_{PLZ}; Output LOW to Tri-state		0.10	2.0	µs	C_L = 15pF, Fig. 34 & 37; S_1 closed
t_{PHZ}; Output HIGH to Tri-state		0.15	2.0	µs	C_L = 15pF, Fig. 34 & 37; S_2 closed
RECEIVER DELAY TIME BETWEEN ACTIVE MODE AND TRI-STATE MODE					
RS-232 MODE					
t_{PZL}; Tri-state to Output LOW		0.12	2.0	µs	C_L = 100pF, Fig. 35 ; S_1 closed
t_{PZH}; Tri-state to Output HIGH		0.10	2.0	µs	C_L = 100pF, Fig. 35 ; S_2 closed
t_{PLZ}; Output LOW to Tri-state		0.10	2.0	µs	C_L = 100pF, Fig. 35 ; S_1 closed
t_{PHZ}; Output HIGH to Tri-state		0.10	2.0	µs	C_L = 100pF, Fig. 35 ; S_2 closed
RS-423 MODE					
t_{PZL}; Tri-state to Output LOW		0.10	2.0	µs	C_L = 100pF, Fig. 35 ; S_1 closed
t_{PZH}; Tri-state to Output HIGH		0.10	2.0	µs	C_L = 100pF, Fig. 35 ; S_2 closed
t_{PLZ}; Output LOW to Tri-state		0.10	2.0	µs	C_L = 100pF, Fig. 35 ; S_1 closed
t_{PHZ}; Output HIGH to Tri-state		0.10	2.0	µs	C_L = 100pF, Fig. 35 ; S_2 closed
RS-422/RS-485 MODES					
t_{PZL}; Tri-state to Output LOW		0.10	2.0	µs	C_L = 100pF, Fig. 35 & 39; S_1 closed
t_{PZH}; Tri-state to Output HIGH		0.10	2.0	µs	C_L = 100pF, Fig. 35 & 39; S_2 closed
t_{PLZ}; Output LOW to Tri-state		0.10	2.0	µs	C_L = 15pF, Fig. 35 & 39; S_1 closed
t_{PHZ}; Output HIGH to Tri-state		0.10	2.0	µs	C_L = 15pF, Fig. 35 & 39; S_2 closed
V.35 MODE					
t_{PZL}; Tri-state to Output LOW		0.10	2.0	µs	C_L = 100pF, Fig. 35 & 39; S_1 closed
t_{PZH}; Tri-state to Output HIGH		0.10	2.0	µs	C_L = 100pF, Fig. 35 & 39; S_2 closed
t_{PLZ}; Output LOW to Tri-state		0.10	2.0	µs	C_L = 15pF, Fig. 35 & 39; S_1 closed
t_{PHZ}; Output HIGH to Tri-state		0.10	2.0	µs	C_L = 15pF, Fig. 35 & 39; S_2 closed

© Copyright 2004 Sipex Corporation

OTHER AC CHARACTERISTICS (Continued)

T_A = +25°C and V_{CC} = +5.0V unless otherwise noted.

TRANSCEIVER TO TRANSCEIVER SKEW					(PER FIGURES 32, 33, 36, 38)
RS-232 Driver		100		ns	$[(t_{phl})_{Tx1} - (t_{phl})_{Tx6,7}]$
		100		ns	$[(t_{plh})_{Tx1} - (t_{plh})_{Tx6,7}]$
RS-232 Receiver		20		ns	$[(t_{phl})_{Rx1} - (t_{phl})_{Rx2,7}]$
		20		ns	$[(t_{phl})_{Rx1} - (t_{phl})_{Rx2,7}]$
RS-422 Driver		2		ns	$[(t_{phl})_{Tx1} - (t_{phl})_{Tx6,7}]$
		2		ns	$[(t_{plh})_{Tx1} - (t_{plh})_{Tx6,7}]$
RS-422 Receiver		3		ns	$[(t_{phl})_{Rx1} - (t_{phl})_{Rx2,7}]$
		3		ns	$[(t_{phl})_{Rx1} - (t_{phl})_{Rx2,7}]$
RS-423 Driver		5		ns	$[(t_{phl})_{Tx2} - (t_{phl})_{Tx3,4,5}]$
		5		ns	$[(t_{plh})_{Tx2} - (t_{plh})_{Tx3,4,5}]$
RS-423 Receiver		5		ns	$[(t_{phl})_{Rx2} - (t_{phl})_{Rx3,4,5}]$
		5		ns	$[(t_{phl})_{Rx2} - (t_{phl})_{Rx3,4,5}]$
V.35 Driver		4		ns	$[(t_{phl})_{Tx1} - (t_{phl})_{Tx6,7}]$
		4		ns	$[(t_{plh})_{Tx1} - (t_{plh})_{Tx6,7}]$
V.35 Receiver		6		ns	$[(t_{phl})_{Rx1} - (t_{phl})_{Rx2,7}]$
		6		ns	$[(t_{phl})_{Rx1} - (t_{phl})_{Rx2,7}]$

© Copyright 2004 Sipex Corporation

TEST CIRCUITS...

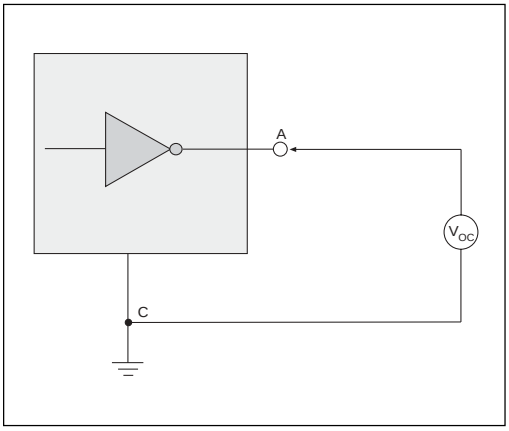


Figure 1. V.28 Driver Output Open Circuit Voltage

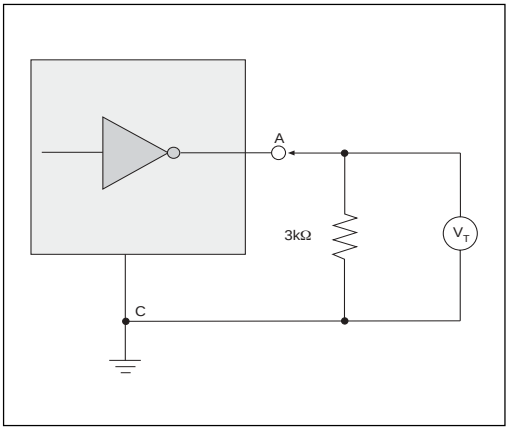


Figure 2. V.28 Driver Output Loaded Voltage

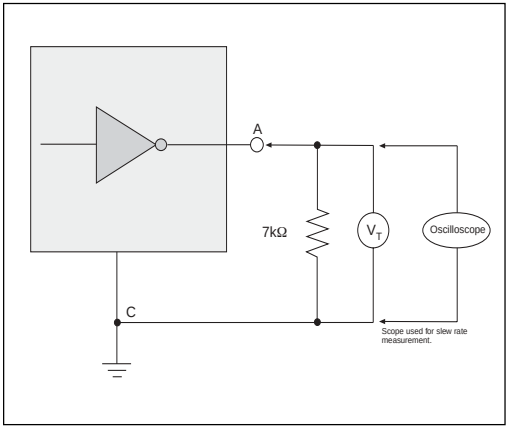


Figure 3. V.28 Driver Output Slew Rate

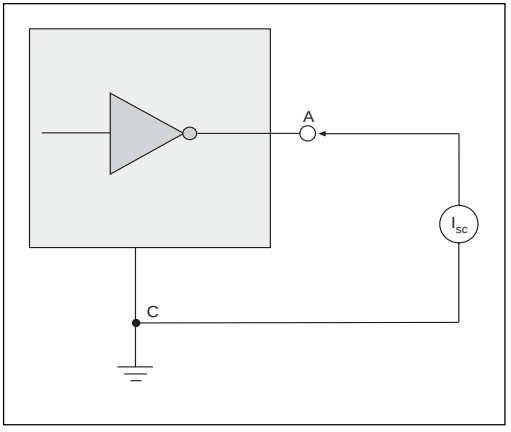


Figure 4. V.28 Driver Output Short-Circuit Current

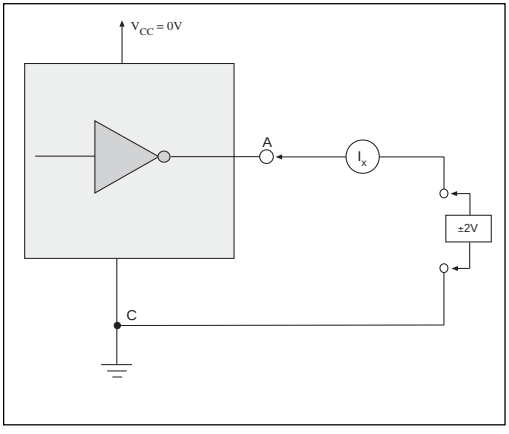


Figure 5. V.28 Driver Output Power-Off Impedance

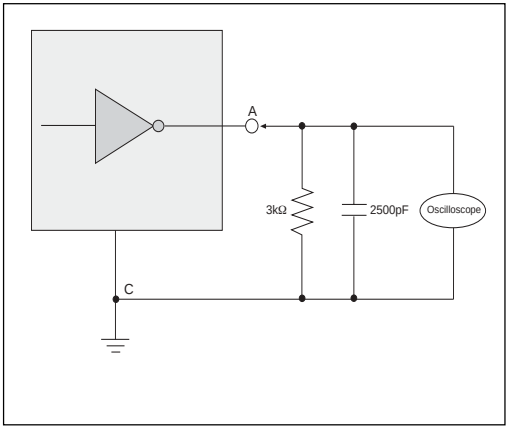


Figure 6. Driver Output Rise/Fall Times

 © Copyright 2004 Sipex Corporation

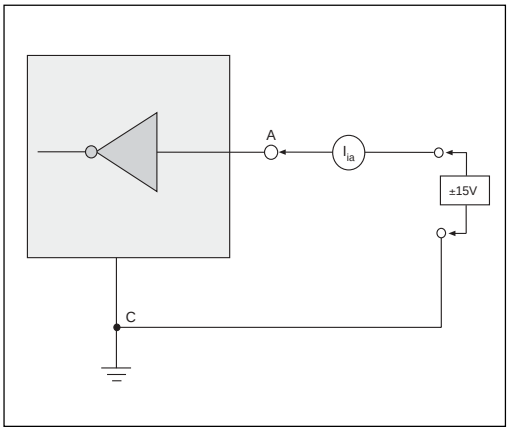


Figure 7. V.28 Receiver Input Impedance

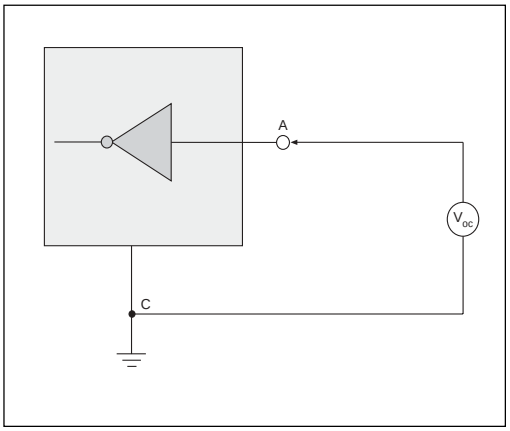


Figure 8. V.28 Receiver Input Open Circuit Bias

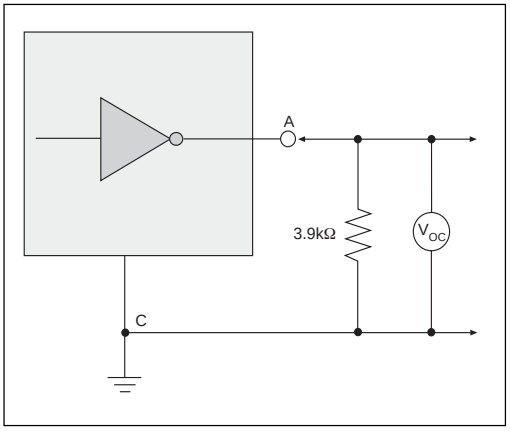


Figure 9. V.10 Driver Output Open-Circuit Voltage

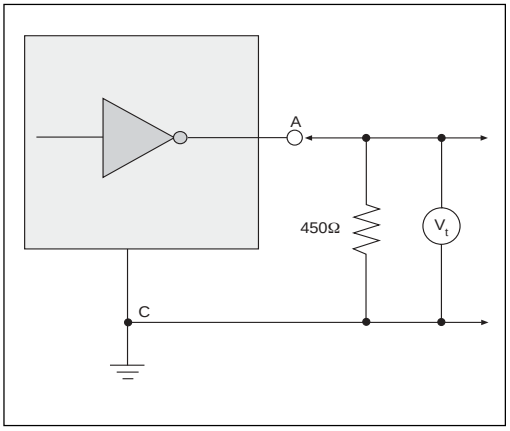


Figure 10. V.10 Driver Output Test Terminated Voltage

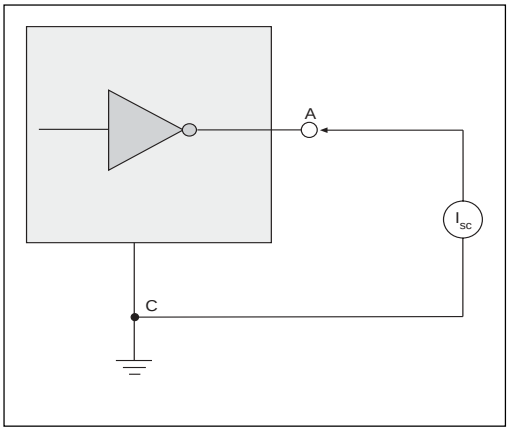


Figure 11. V.10 Driver Output Short-Circuit Current

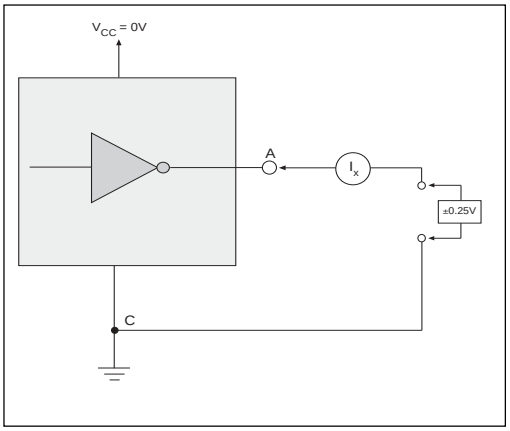


Figure 12. V.10 Driver Output Power-Off Current

 © Copyright 2004 Sipex Corporation

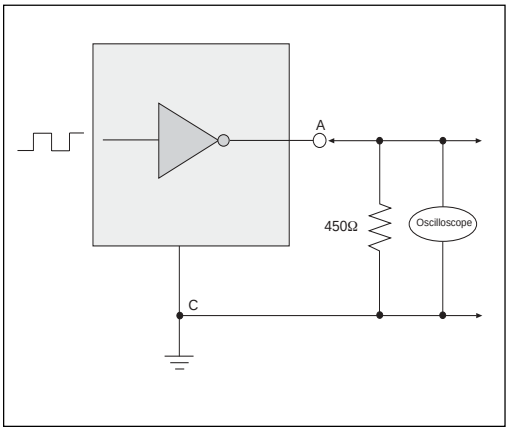


Figure 13. V.10 Driver Output Transition Time

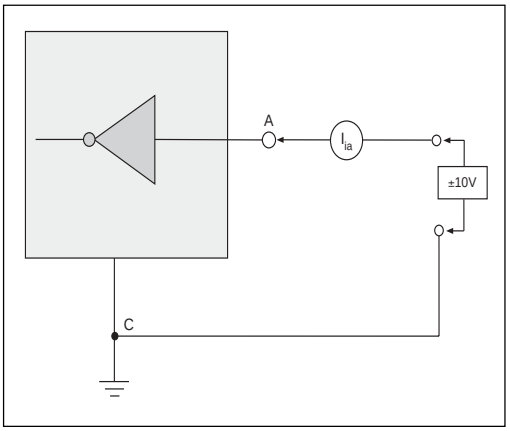


Figure 14. V.10 Receiver Input Current

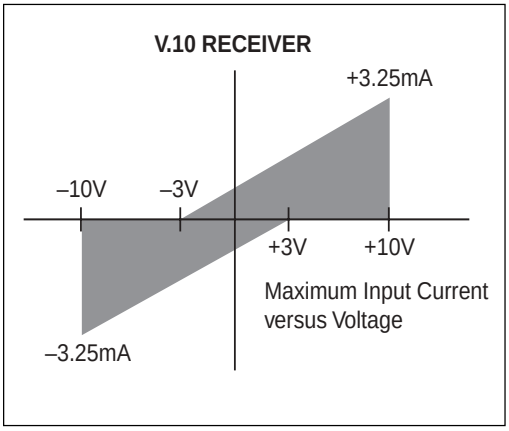


Figure 15. V.10 Receiver Input IV Graph

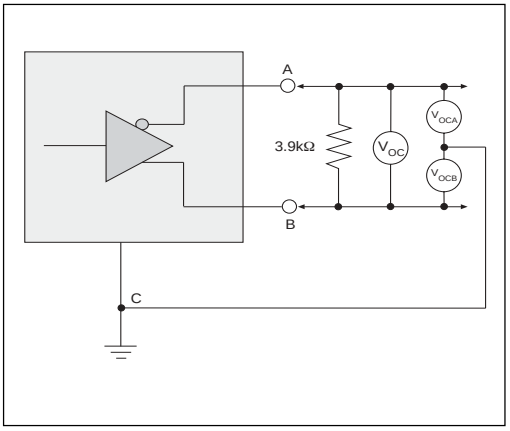


Figure 16. V.11 Driver Output Open-Circuit Voltage

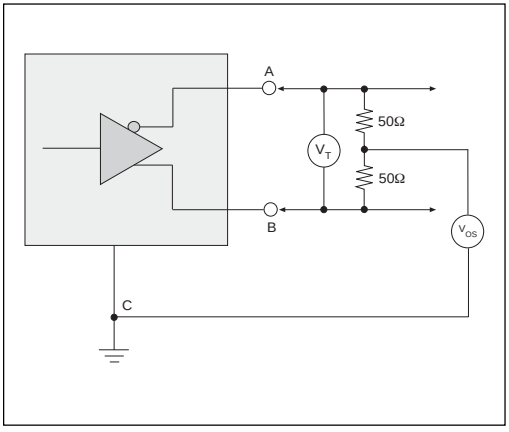


Figure 17. V.11 Driver Output Test Terminated Voltage

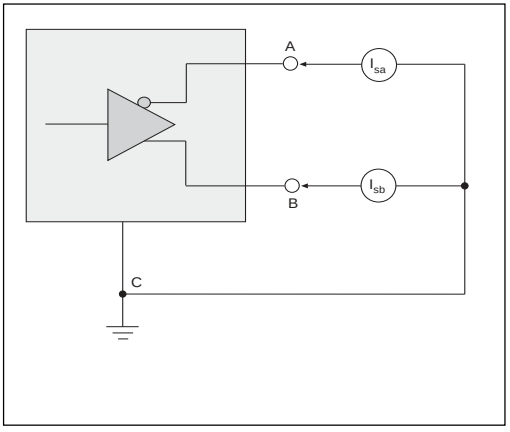


Figure 18. V.11 Driver Output Short-Circuit Current

 © Copyright 2004 Sipex Corporation

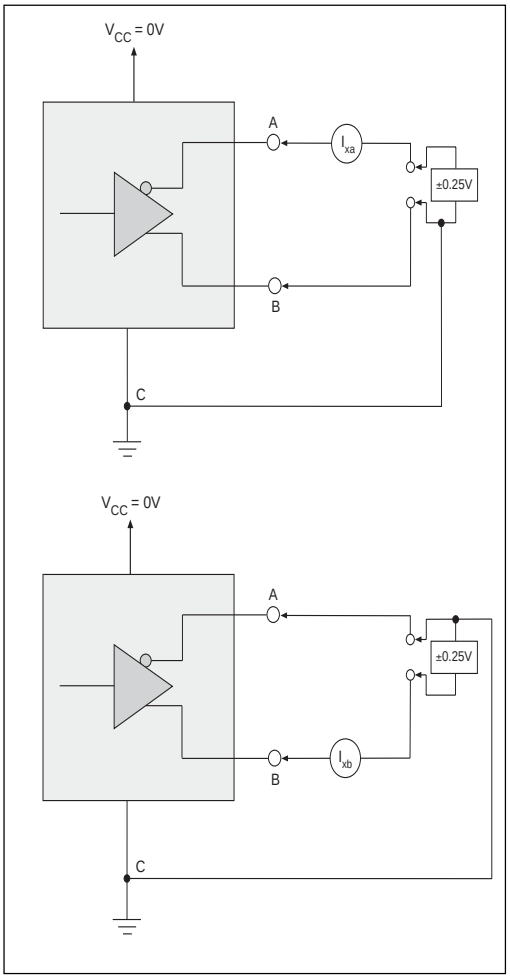


Figure 19. V.11 Driver Output Power-Off Current

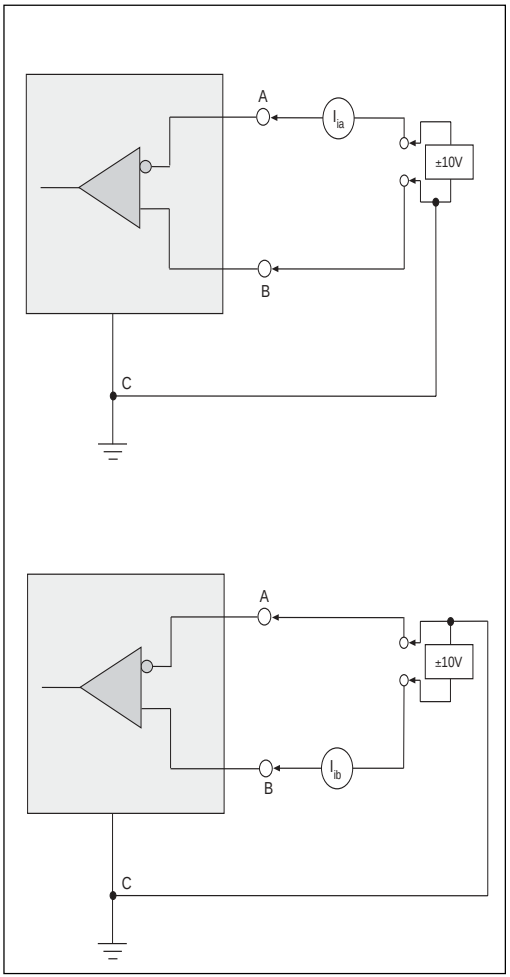


Figure 20. V.11 Receiver Input Current

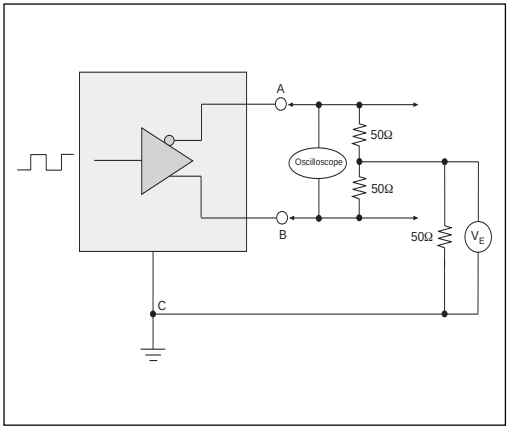


Figure 21. V.11 Driver Output Rise/Fall Time

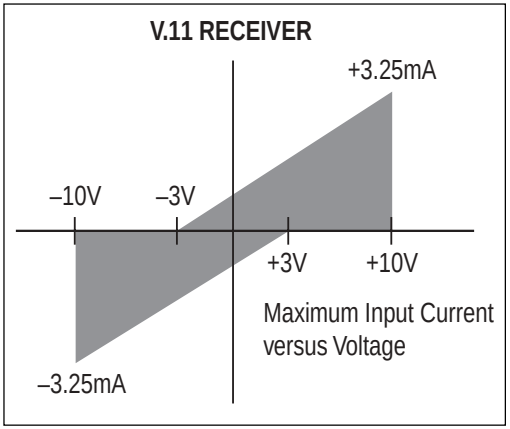


Figure 22. V.11 Receiver Input IV Graph

 © Copyright 2004 Sipex Corporation

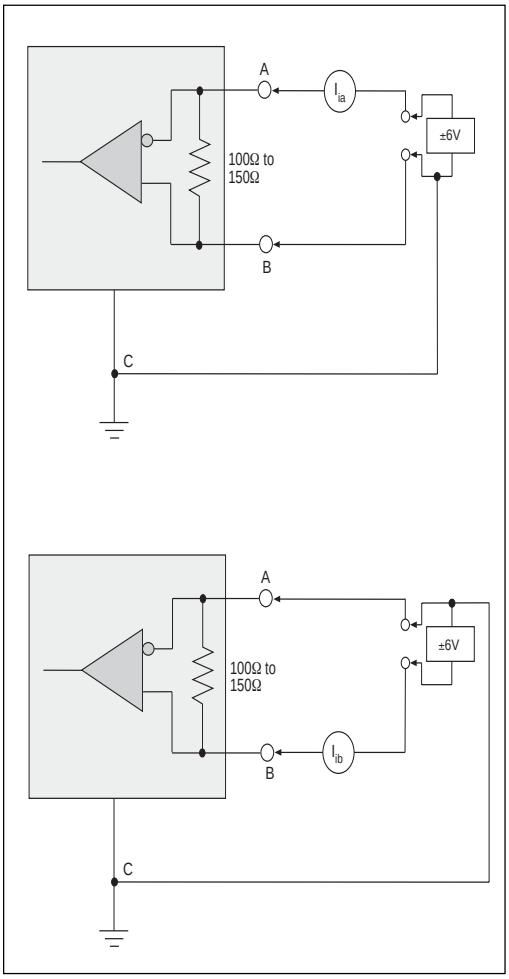


Figure 23. V.11 Receiver Input Current w/ Termination

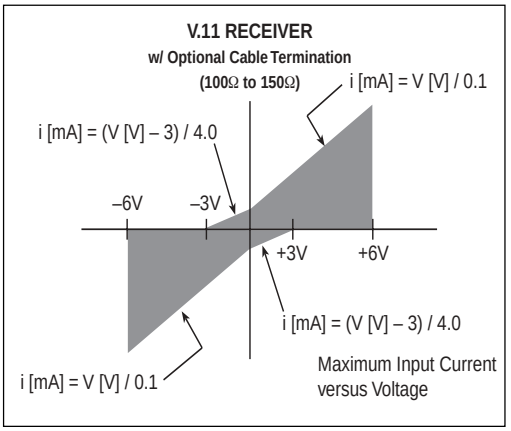


Figure 24. V.11 Receiver Input Graph w/ Termination

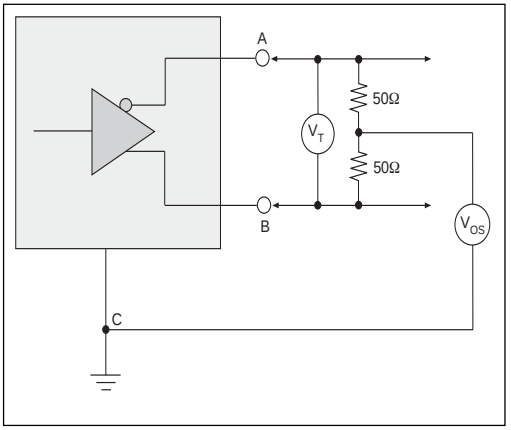


Figure 25. V.35 Driver Output Test Terminated Voltage

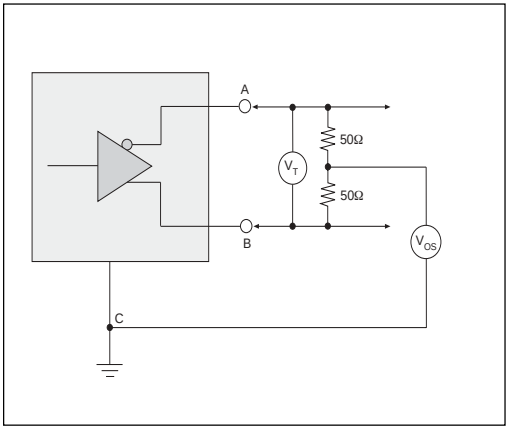


Figure 26. V.35 Driver Output Offset Voltage

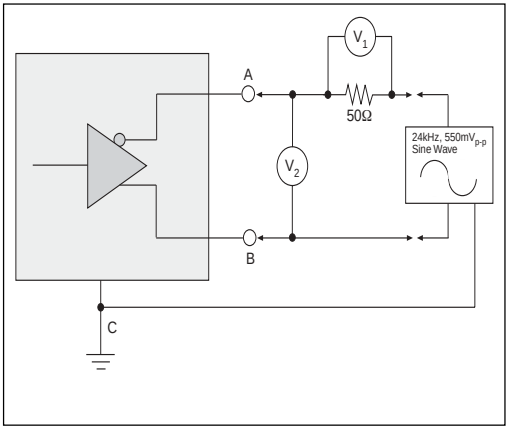


Figure 27. V.35 Driver Output Source Impedance

 © Copyright 2004 Sipex Corporation

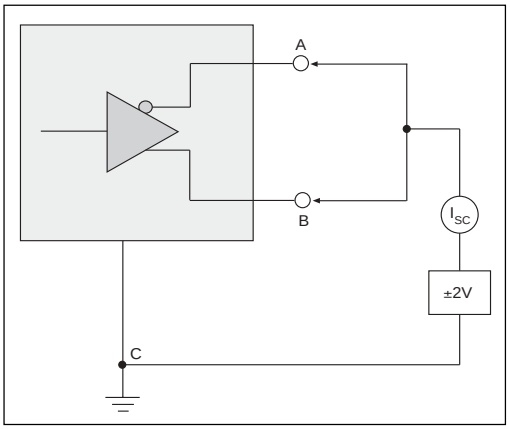


Figure 28. V.35 Driver Output Short-Circuit Impedance

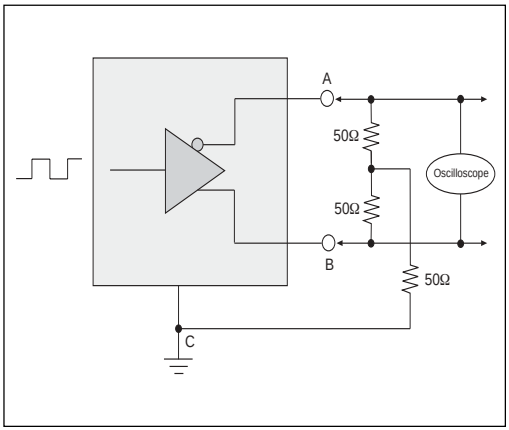


Figure 29. V.35 Driver Output Rise/Fall Time

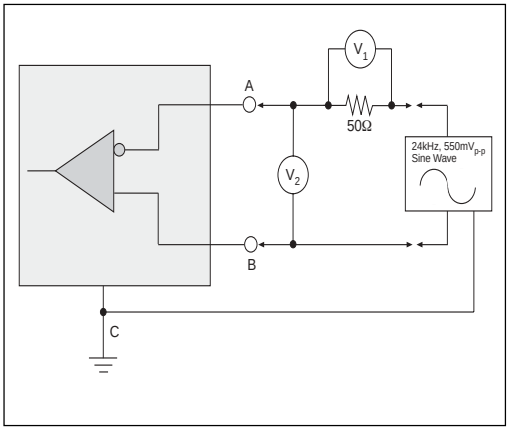


Figure 30. V.35 Receiver Input Source Impedance

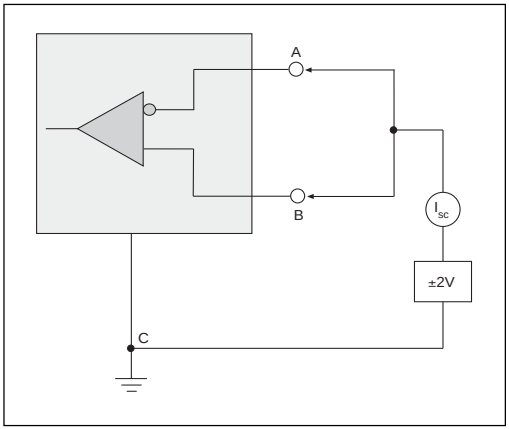


Figure 31. V.35 Receiver Input Short-Circuit Impedance

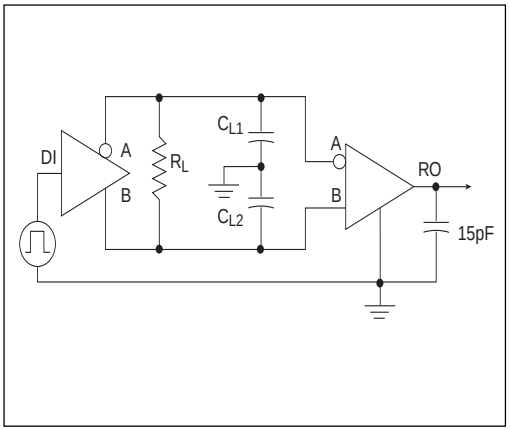


Figure 32. Driver/Receiver Timing Test Circuit

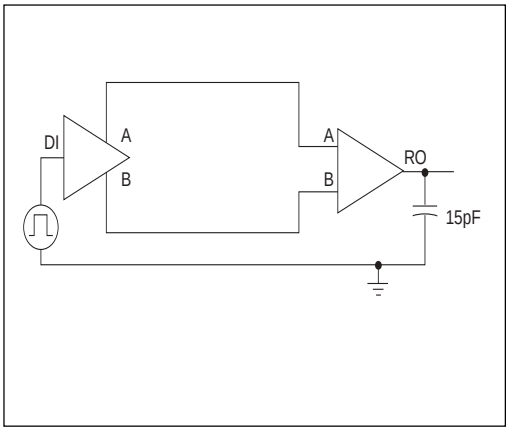


Figure 33. Timing Test Ckt. (V.35 mode only for SP514)

 © Copyright 2004 Sipex Corporation

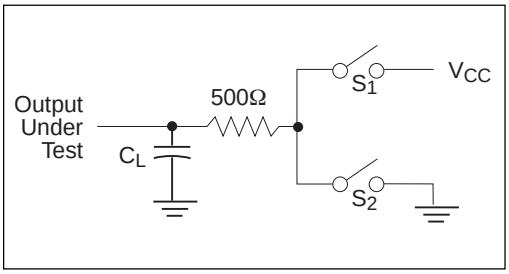


Figure 34. Driver Timing Test Load Circuit

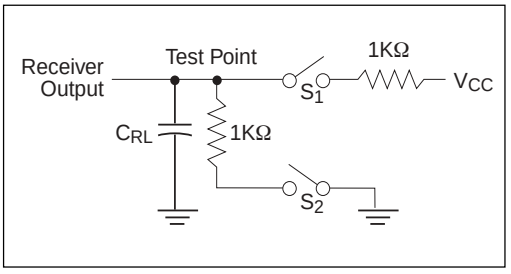


Figure 35. Receiver Timing Test Load Circuit

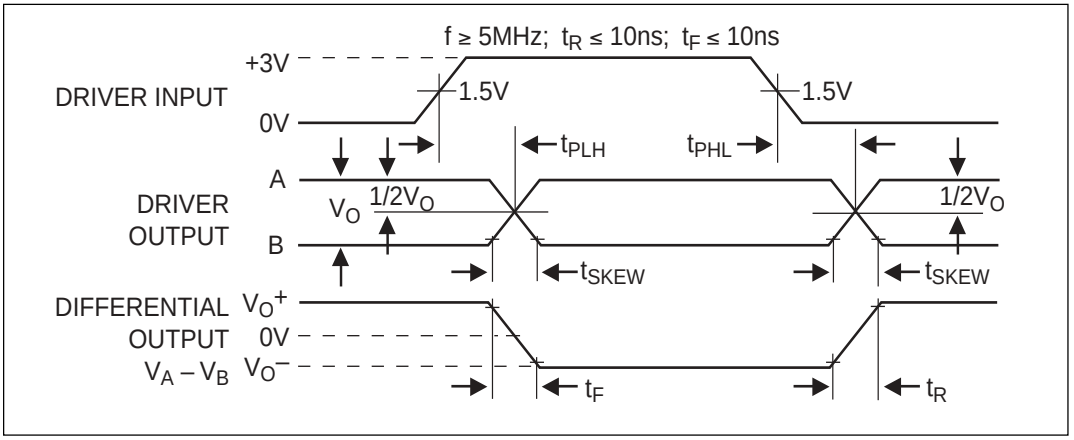


Figure 36. Driver Propagation Delays

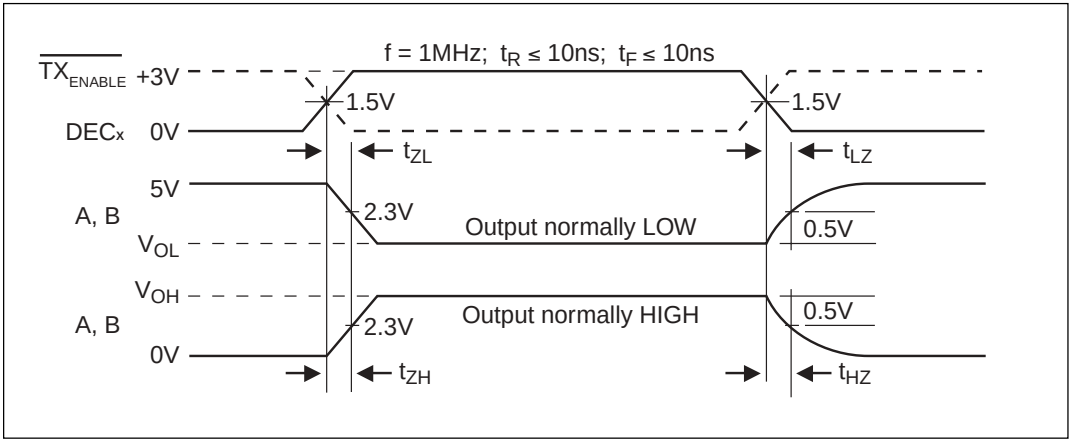


Figure 37. Driver Enable and Disable Times

Note: Figure 36 shown above is corrected from Figure 5 in SP504 Datasheet. Figure 5 in the SP504 Datasheet is incorrect where A and B are reversed and the $V_A - V_B$ output should be inverted.

 © Copyright 2004 Sipex Corporation

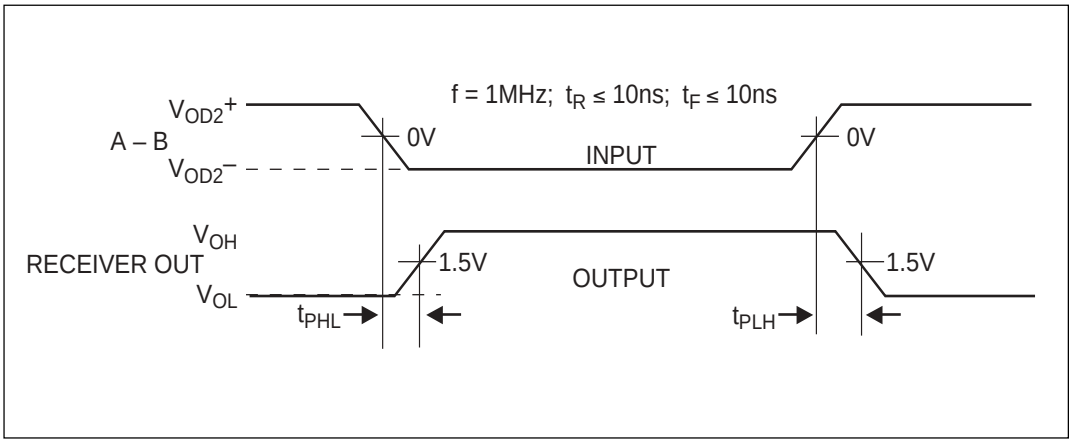


Figure 38. Receiver Propagation Delays

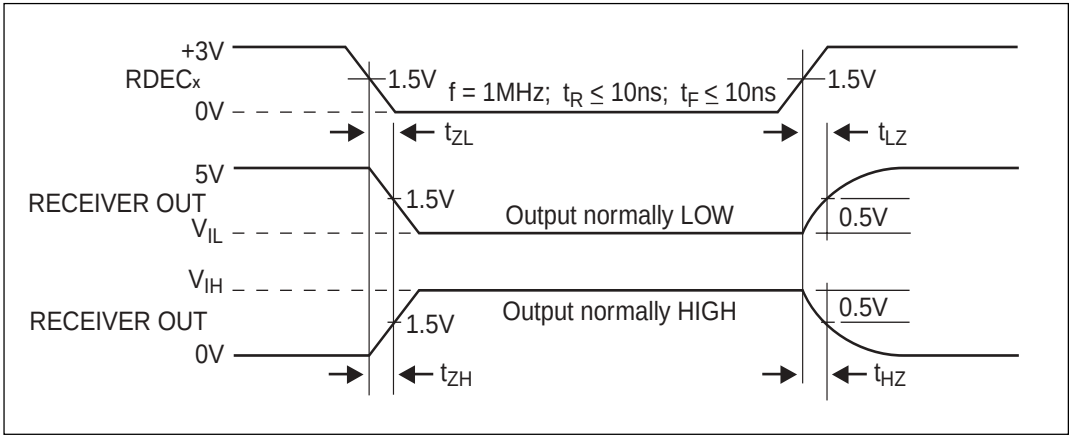
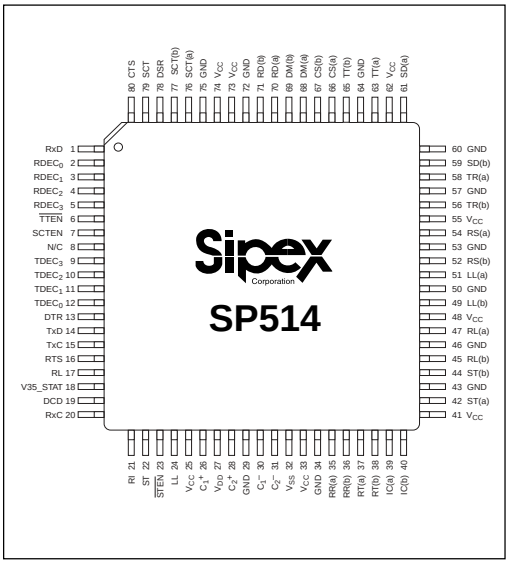


Figure 39. Receiver Enable and Disable Times

Note: Figure 38 shown above is corrected from Figure 7 in the original SP504 Datasheet. Figure 7 in the original SP504 Datasheet is incorrect where the RECEIVER OUTPUT should be inverted.

 © Copyright 2004 Sipex Corporation

PINOUT…



PIN ASSIGNMENTS…
CLOCK AND DATA GROUP

Pin 1 — RxD — Receive Data; TTL output, sourced from RD(a) and RD(b) inputs.

Pin 14 — TxD — TTL input ; transmit data source for SD(a) and SD(b) outputs.

Pin 15 — TxC — Transmit Clock; TTL input for TT driver outputs.

Pin 20 — RxC — Receive Clock; TTL output sourced from RT(a) and RT(b) inputs.

Pin 22 — ST — Send Timing; TTL input; source for ST(a) and ST(b) outputs.

Pin 37 — RT(a) — Receive Timing; analog input, inverted; source for RxC.

Pin 38 — RT(b) — Receive Timing; analog input, non-inverted; source for RxC.

Pin 42 — ST(a) — Send Timing; analog output, inverted; sourced from ST.

Pin 44 — ST(b) — Send Timing; analog output, non-inverted; sourced from ST.

Pin 59 — SD(b) — Analog Out — Send data, non-inverted; sourced from TxD.

Pin 61 — SD(a) — Analog Out — Send data, inverted; sourced from TxD.

Pin 63 — TT(a) — Analog Out — Terminal Timing, inverted; sourced from TxC

Pin 65 — TT(b) — Analog Out — Terminal Timing, non–inverted; sourced from TxC.

Pin 70 — RD(a) — Receive Data, analog input; inverted; source for RxD.

Pin 71 — RD(b) — Receive Data; analog input; non-inverted; source for RxD.

Pin 76 — SCT(a) — Serial Clock Transmit; analog input, inverted; source for SCT.

Pin 77 — SCT(b) — Serial Clock Transmit: analog input, non–inverted; source for SCT

Pin 79 — SCT — Serial Clock Transmit; TTL output; sources from SCT(a) and SCT(b) inputs.

CONTROL LINE GROUP

Pin 13 — DTR — Data Terminal Ready; TTL input; source for TR(a) and TR(b) outputs.

Pin 16 — RTS — Ready To Send; TTL input; source for RS(a) and RS(b) outputs.

Pin 17 — RL — Remote Loopback; TTL input; source for RL(a) and RL(b) outputs.

Pin 18 — V35_STAT — V.35 Status; TTL output; outputs logic high when in V.35 mode.

Pin 19 — DCD— Data Carrier Detect; TTL output; sourced from RR(a) and RR(b) inputs.

Pin 21 — RI — Ring Indicate; TTL output; sourced from IC(a) and IC(b) inputs.

Pin 24 — LL — Local Loopback; TTL input; source for LL(a) and LL(b) outputs.

Pin 35 — RR(a)— Receiver Ready; analog input, inverted; source for DCD.

Pin 36 — RR(b)— Receiver Ready; analog input, non-inverted; source for DCD.

Pin 39 — IC(a)— Incoming Call; analog input, inverted; source for RI.

 © Copyright 2004 Sipex Corporation

Pin 40 — IC(b)— Incoming Call; analog input,non-inverted; source for RI.

Pin 45 — RL(b) — Remote Loopback; analog output, non-inverted; sourced from RL.

Pin 47 — RL(a) — Remote Loopback; analog output inverted; sourced from RL.

Pin 49— LL(b) — Local Loopback; analog output, non-inverted; sourced from LL.

Pin 51 — LL(a) — Local Loopback; analog output, inverted; sourced from LL.

Pin 52 — RS(b) — Ready To Send; analog output, non-inverted; sourced from RTS.

Pin 54 — RS(a) — Ready To Send; analog output, inverted; sourced from RTS.

Pin 56 — TR(b) — Terminal Ready; analog output, non-inverted; sourced from DTR.

Pin 58 — TR(a) — Terminal Ready; analog output, inverted; sourced from DTR.

Pin 66 — CS(a)— Clear To Send; analog input, inverted; source for CTS.

Pin 67 — CS(b)— Clear To Send; analog input, non-inverted; source for CTS.

Pin 68 — DM(a)— Data Mode; analog input, inverted; source for DSR.

Pin 69 — DM(b)— Data Mode; analog input, non-inverted; source for DSR

Pin 78 — DSR— Data Set Ready; TTL output; sourced from DM(a), DM(b) inputs.

Pin 80 — CTS— Clear To Send; TTL output; sourced from CS(a) and CS(b) inputs.

CONTROL REGISTERS

Pins 2–5 — $RDEC_0$ – $RDEC_3$ — Receiver decode register; configures receiver modes; TTL inputs.

Pin 6 — $\overline{TTEN}$ — Enables TT driver, active low; TTL input.

Pin 7 — SCTEN — Enables SCT receiver; active high; TTL input.

Pins 12–9 — $TDEC_0$ – $TDEC_3$ — Transmitter decode register; configures transmitter modes; TTL inputs.

Pin 23 — $\overline{STEN}$ — Enables ST driver; active low; TTL input.

POWER SUPPLIES

Pins 25, 33, 41, 48, 55, 62, 73, 74 — V_{CC} — +5V input.

Pins 29, 34, 43, 46, 50, 53, 57, 60, 64, 72, 75 — GND — Ground.

Pin 27 — V_{DD} +10V Charge Pump Capacitor — Connects from V_{DD} to V_{CC}. Suggested capacitor size is 22µF, 16V.

Pin 32 — V_{SS} –10V Charge Pump Capacitor — Connects from ground to V_{SS}. Suggested capacitor size is 22µF, 16V.

Pins 26 and 30 — C_1^+ and C_1^- — Charge Pump Capacitor — Connects from C_1^+ to C_1^-. Suggested capacitor size is 22µF, 16V.

Pins 28 and 31 — C_2^+ and C_2^- — Charge Pump Capacitor — Connects from C_2^+ to C_2^-. Suggested capacitor size is 22µF, 16V.

NOTE: NC pins should be left floating; internal signals may be present.

 © Copyright 2004 Sipex Corporation

SP514 Driver Mode Selection

Pin Label	Mode:	RS232	V.35	RS422	RS485	RS449	EIA530	EIA-530A	V.36
$TDEC_3$–$TDEC_0$	0000	0010	1110	0100	0101	1100	1101	1111	0110
SD(a)	tri-state	V.28	V.35–	V.11–	RS485–	V.11–	V.11–	V.11–	V.11–
SD(b)	tri-state	tri-state	V.35+	V.11+	RS485+	V.11+	V.11+	V.11+	V.11+
TR(a)	tri-state	V.28	V.28	V.11–	RS485–	V.11–	V.11–	V.10	V.10
TR(b)	tri-state	tri-state	tri-state	V.11+	RS485+	V.11+	V.11+	tri-state	tri-state
RS(a)	tri-state	V.28	V.28	V.11–	RS485–	V.11–	V.11–	V.11–	V.10
RS(b)	tri-state	tri-state	tri-state	V.11+	RS485+	V.11+	V.11+	V.11+	tri-state
RL(a)	tri-state	V.28	V.28	V.11–	RS485–	V.10	V.10	V.11–	V.10
RL(b)	tri-state	tri-state	tri-state	V.11+	RS485+	tri-state	tri-state	V.11+	tri-state
LL(a)	tri-state	V.28	V.28	V.11–	RS485–	V.10	V.10	V.10	V.10
LL(b)	tri-state	tri-state	tri-state	V.11+	RS485+	tri-state	tri-state	tri-state	tri-state
ST(a)	tri-state	V.28	V.35–	V.11–	RS485–	V.11–	V.11–	V.11–	V.11–
ST(b)	tri-state	tri-state	V.35+	V.11+	RS485+	V.11+	V.11+	V.11+	V.11+
TT(a)	tri-state	V.28	V.35–	V.11–	RS485–	V.11–	V.11–	V.11–	V.11–
TT(b)	tri-state	tri-state	V.35+	V.11+	RS485+	V.11+	V.11+	V.11+	V.11+

SP514 Receiver Mode Selection

Pin Label	Mode:	RS232	V.35	RS422	RS485	RS449	EIA530	EIA-530A	V.36
$RDEC_3$–$RDEC_0$	0000	0010	1110	0100	0101	1100	1101	1111	0110
RD(a)	>12kΩ to GND	V.28	V.35–	V.11–	RS485–	V.11–	V.11–	V.11–	V.11–
RD(b)	>12kΩ to GND	>12kΩ to GND	V.35+	V.11+	RS485+	V.11+	V.11+	V.11+	V.11+
RT(a)	>12kΩ to GND	V.28	V.35–	V.11–	RS485–	V.11–	V.11–	V.11–	V.11–
RT(b)	>12kΩ to GND	>12kΩ to GND	V.35+	V.11+	RS485+	V.11+	V.11+	V.11+	V.11+
CS(a)	>12kΩ to GND	V.28	V.28	V.11–	RS485–	V.11–	V.11–	V.11–	V.10
CS(b)	>12kΩ to GND	>12kΩ to GND	>12kΩ to GND	V.11+	RS485+	V.11+	V.11+	V.11+	>12kΩ to GND
DM(a)	>12kΩ to GND	V.28	V.28	V.11–	RS485–	V.11–	V.11–	V.10	V.10
DM(b)	>12kΩ to GND	>12kΩ to GND	>12kΩ to GND	V.11+	RS485+	V.11+	V.11+	>12kΩ to GND	>12kΩ to GND
RR(a)	>12kΩ to GND	V.28	V.28	V.11–	RS485–	V.11–	V.11–	V.11–	V.10
RR(b)	>12kΩ to GND	>12kΩ to GND	>12kΩ to GND	V.11+	RS485+	V.11+	V.11+	V.11+	>12kΩ to GND
IC(a)	>12kΩ to GND	V.28	V.28	V.11–	RS485–	V.10	V.10	V.10	V.10
IC(b)	>12kΩ to GND	>12kΩ to GND	>12kΩ to GND	V.11+	RS485+	>12kΩ to GND	>12kΩ to GND	>12kΩ to GND	>12kΩ to GND
SCT(a)	>12kΩ to GND	V.28	V.35–	V.11–	RS485–	V.11–	V.11–	V.11–	V.11–
SCT(b)	>12kΩ to GND	>12kΩ to GND	V.35+	V.11+	RS485+	V.11+	V.11+	V.11+	V.11+

© Copyright 2004 Sipex Corporation

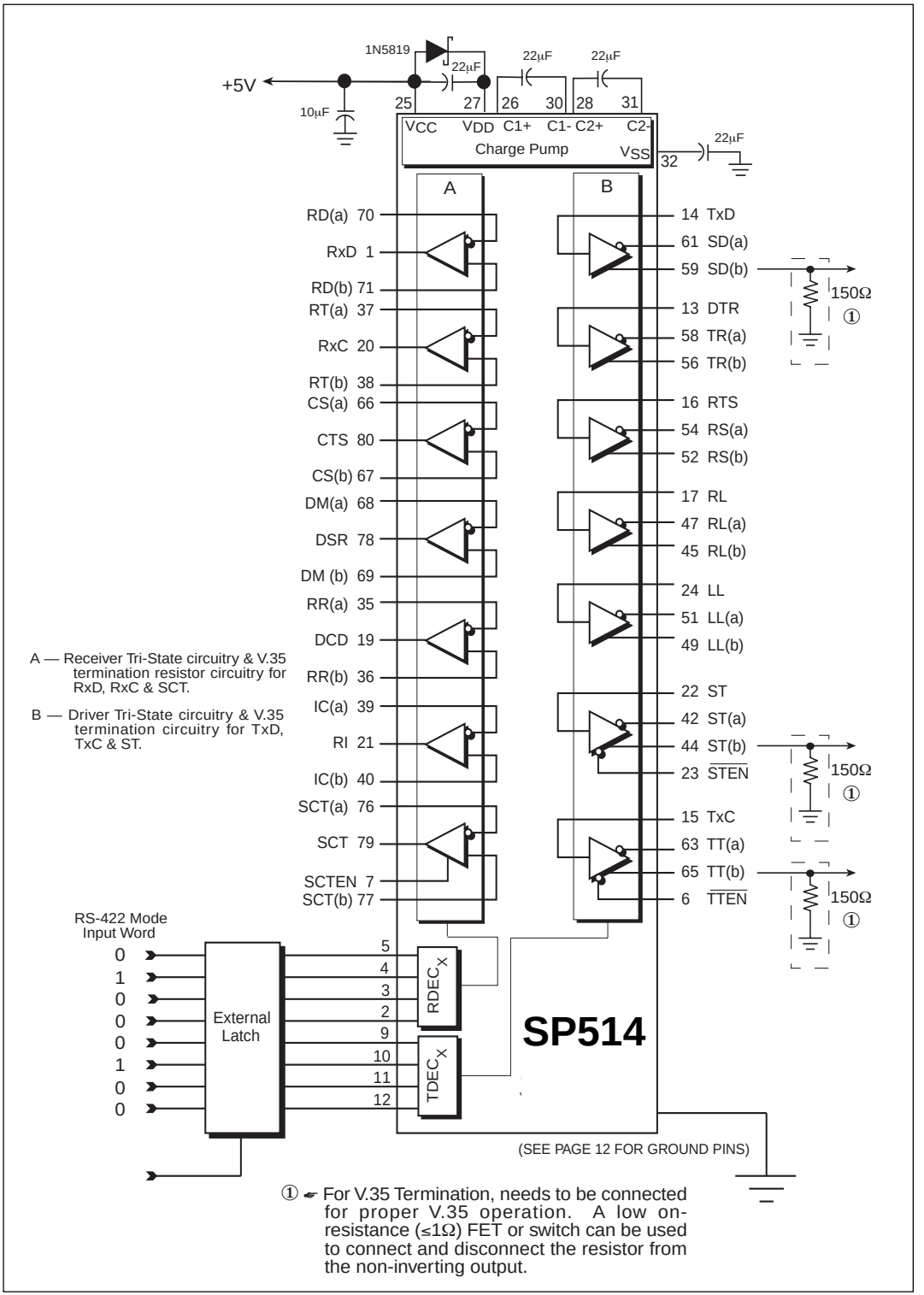
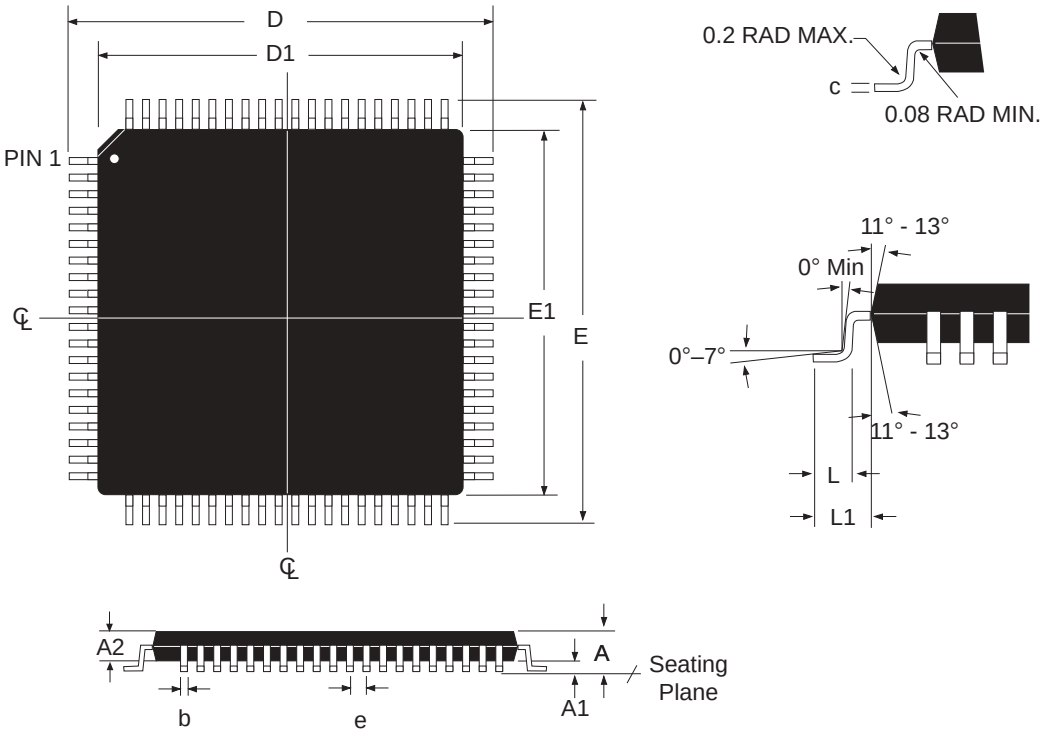


Figure 40. SP514 Typical Operating Circuit

 © Copyright 2004 Sipex Corporation

PACKAGE: 80 Pin LQFP



DIMENSIONS Minimum/Maximum (mm)	80-PIN LQFP JEDEC MS-026 (BEC) Variation		
SYMBOL	MIN	NOM	MAX
A			1.60
A1	0.05		0.15
A2	1.35	1.40	1.45
b	0.22	0.32	0.38
D	16.00 BSC		
D1	14.00 BSC		
e	0.65 BSC		
E	16.00 BSC		
E1	14.00 BSC		
N	80		

COMMON DIMENTIONS			
SYMBL	MIN	NOM	MAX
c	0.11		23.00
L	0.45	0.60	0.75
L1	1.00 BASIC		

80 PIN LQFP

© Copyright 2004 Sipex Corporation

ORDERING INFORMATION

Model	Temperature Range	Package Types
SP514CF	0°C to +70°C	80–pin JEDEC (BE-2 Outline) LQFP

REVISION HISTORY

DATE	REVISION	DESCRIPTION
3/05/04	A	Implemented tracking revision.

ANALOG EXCELLENCE

Sipex Corporation

Headquarters and
Sales Office
233 South Hillview Drive
Milpitas, CA 95035
TEL: (408) 934-8700
FAX: (408) 946-9001

Sales Office
22 Linnell Circle
Billerica, MA 01821
TEL: (978) 667-8700
FAX: (978) 670-9001
e-mail: sales@sipex.com

Sipex Corporation reserves the right to make changes to any products described herein. Sipex does not assume any liability arising out of the application or use of any product or circuit described hereing; neither does it convey any license under its patent rights nor the rights of others.